



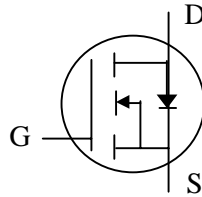
N-channel Enhancement-mode Power MOSFET

Simple Drive Requirement

Low Gate Charge

Fast Switching Characteristics

RoHS-compliant, Halogen-free



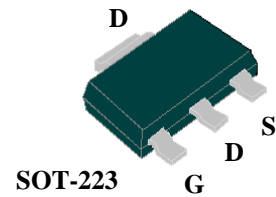
BV_{DSS}	100V
$R_{DS(ON)}$	120mΩ
I_D	3.2A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP9997GK-HF-3 is in the popular SOT-223 small surface-mount package which is widely used in commercial and industrial applications where a small board footprint is required.

This device is well suited for use in medium current applications such as load switches.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D at $T_A=25^{\circ}C$	Continuous Drain Current ³	3.2	A
I_D at $T_A=70^{\circ}C$	Continuous Drain Current ³	2.6	A
I_{DM}	Pulsed Drain Current ¹	20	A
P_D at $T_A=25^{\circ}C$	Total Power Dissipation	2.8	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient	45	°C/W

Ordering Information

AP9997GK-HF-3TR RoHS-compliant halogen-free SOT-223, shipped on tape and reel, 3000pcs/reel



Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=3A$	-	-	120	mW
		$V_{GS}=4.5V, I_D=2A$	-	-	200	mW
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=3A$	-	3	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=80V, V_{GS}=0V$	-	-	25	μA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{DS}=80V, V_{GS}=0V$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_D=3A$	-	14	22	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=80V$	-	1.5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	5.5	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=50V$	-	4.5	-	ns
t_r	Rise Time	$I_D=1A$	-	7	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=10V$	-	18	-	ns
t_f	Fall Time	$R_D=50\Omega$	-	6	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	450	720	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	65	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	50	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=1.5A, V_{GS}=0V$	-	-	1.3	V
t_{rr}	Reverse Recovery Time ²	$I_S=3A, V_{GS}=0V,$	-	39	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	62	-	nC

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test - pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface mounted on 1in^2 copper pad of FR4 board, $t \leq 10\text{sec}$; 120°C/W when mounted on minimum copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

APEC RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN.



Typical Electrical Characteristics

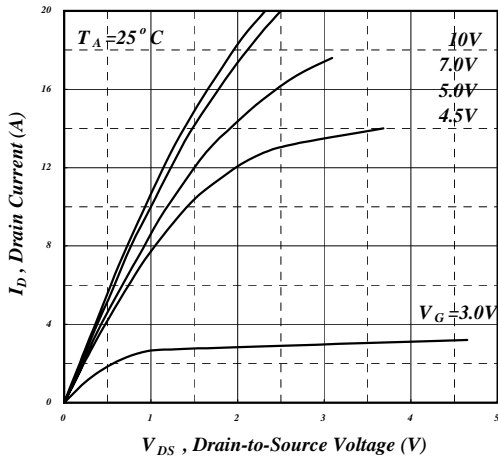


Fig 1. Typical Output Characteristics

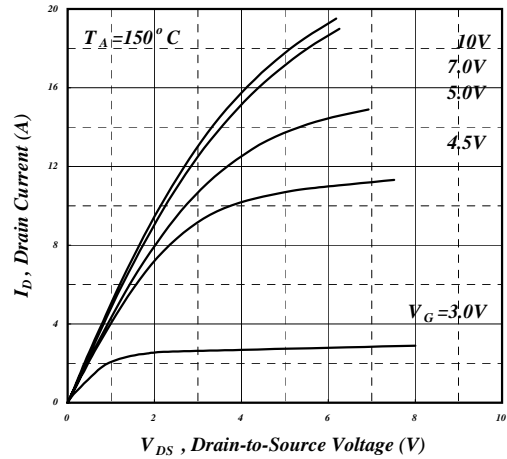


Fig 2. Typical Output Characteristics

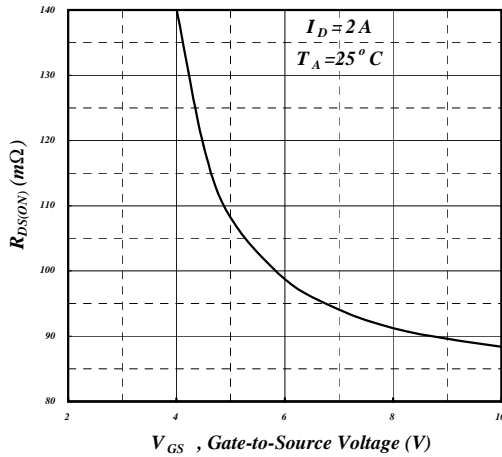


Fig 3. On-Resistance vs. Gate Voltage

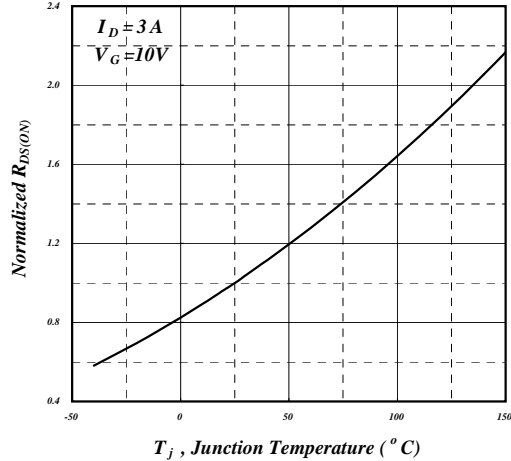


Fig 4. Normalized On-Resistance vs. Junction Temperature

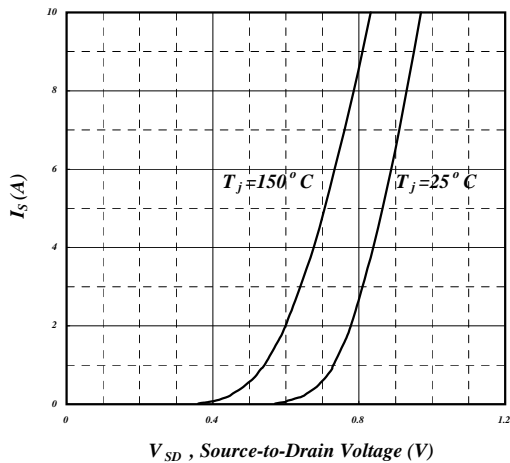


Fig 5. Forward Characteristic of Reverse Diode

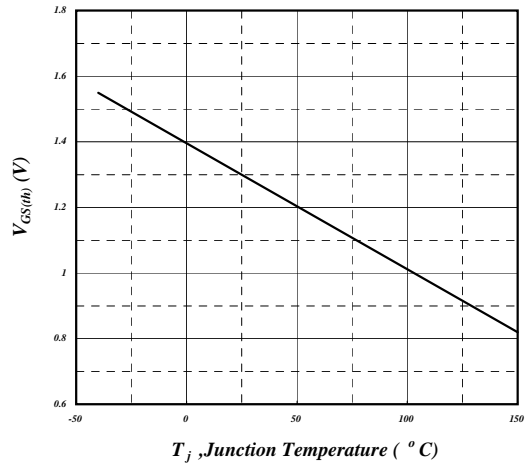


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical Electrical Characteristics (cont.)

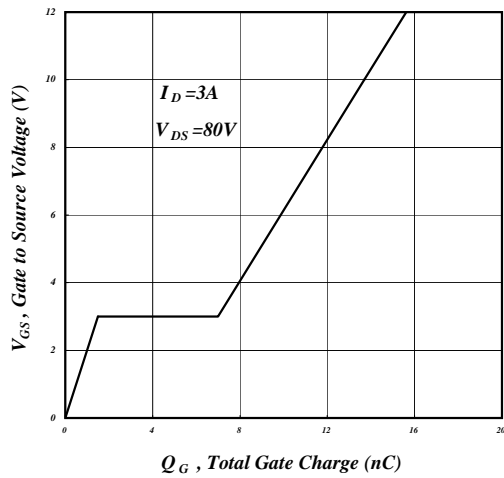


Fig 7. Gate Charge Characteristics

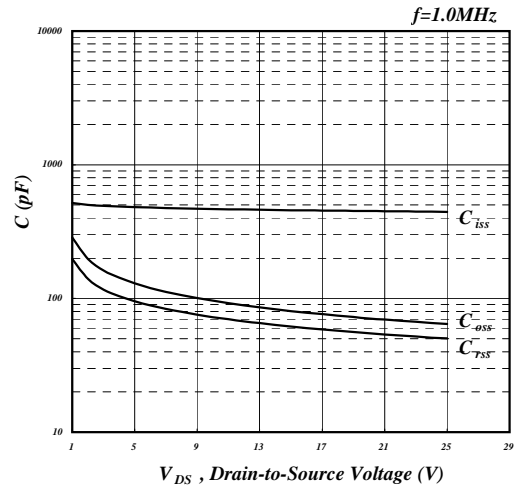


Fig 8. Typical Capacitance Characteristics

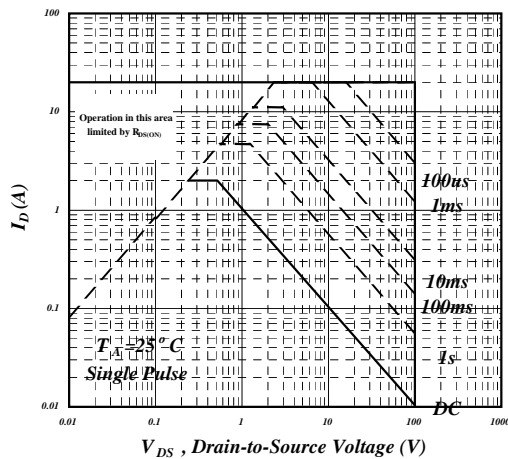


Fig 9. Maximum Safe Operating Area

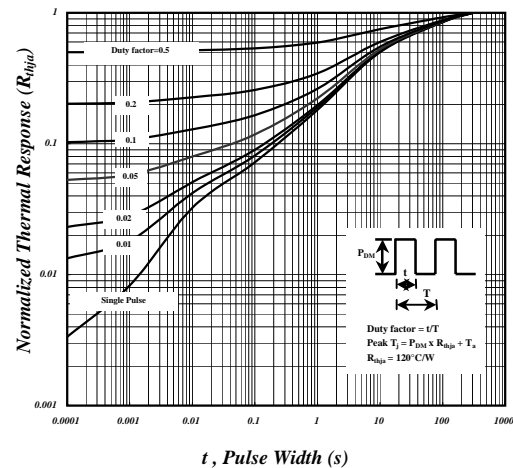


Fig 10. Effective Transient Thermal Impedance

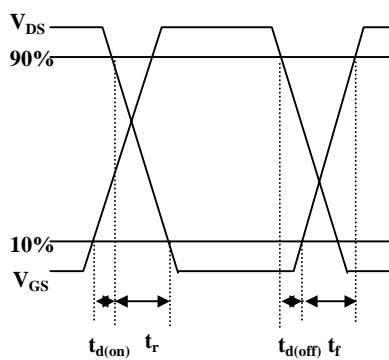


Fig 11. Switching Time Waveform

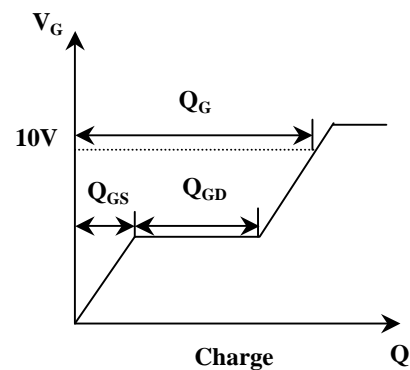
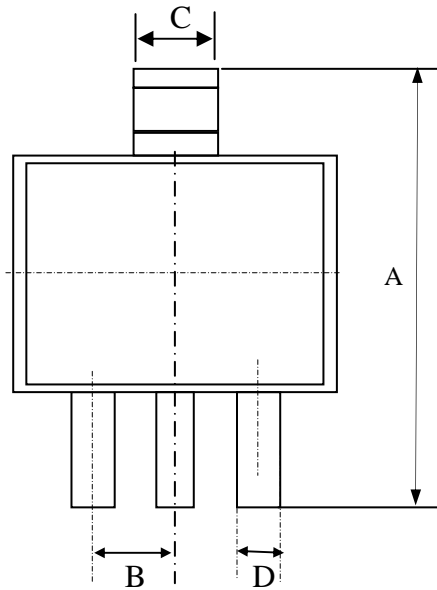


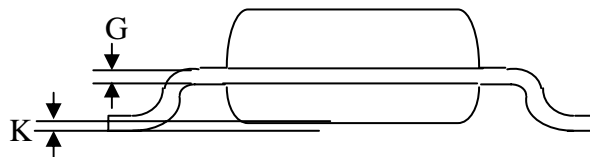
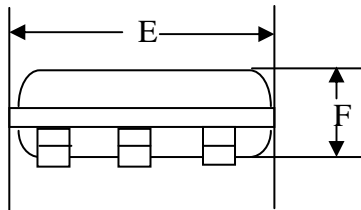
Fig 12. Gate Charge Waveform



Package Dimensions: SOT-223



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	6.70	7.00	7.30
B	---	2.3	---
C	2.90	3.00	3.10
D	0.60	0.70	0.80
G	0.25	0.30	0.35
E	6.30	6.50	6.70
F	1.40	1.60	1.80
K	0.02	0.06	0.10



1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information: SOT-223

